



IPC/CE/31/2
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SPECIAL UNION FOR THE INTERNATIONAL PATENT CLASSIFICATION (IPC UNION)

COMMITTEE OF EXPERTS

Thirty-First Session Geneva, February 25 to March 1, 2002

PROPOSED AMENDMENTS TO THE IPC

Document prepared by the International Bureau

1. The amendments to the IPC contained in the Technical Annexes to this document have been approved by the IPC Revision Working Group, at its second to sixth sessions, and are herewith submitted to the Committee of Experts for adoption. These amendments concern the following IPC subclasses:

<u>Area</u>	Annex	<u>Project</u>	<u>Area</u>	<u>Annex</u>	<u>Project</u>
A 61 B	1	341	E 04 G	15	367
A 61 K	2	341	E 06 C	16	367
A 61 L	3	341	F 16 B	17	366
A 61 N	4	341	G 01 M	18	419
B 02 C	5	346	G 06 F	19	406
B 29 B	6	346	G 11 C	20	406
B 60 R	7	354	G 21 B	21	421
B 61 L	8	389	G 21 C	22	421
B 65 G	9	358, 408	H 01 B	23	407
B 66 D	10	367	H 01 L	24	408, 423
B 66 F	11	367	H 01 S	25	423
C 09 J	12	341	H 05 B	26	423
E 03 C	13	346	H 05 H	27	421
E 04 F	14	366			

2. The amendments referred to in the preceding paragraph have been compiled by the International Bureau from the following Annexes of the reports of the IPC Revision Working Group (in the order of the revision projects):

Project	Class or subclass affected	ss											
	arrected	6.	/5	5,	/3	4/5 3/3			2/3 1/2				
		Е	F	Е	F	Е	F	Е	F	Е	F	Е	F
341	A 61 B				2	2E	2F	18					
	A 61 K				3	3E	3F	19					
	A 61 L						4	20					
	A 61 N					5E, <i>E</i>	5F	21					
	C 09 J						6	22					
346	B 02 C					7E	7F	30					
	B 29 B					8E, <i>E</i>	8F	31					
	E 03 C			4E, <i>E</i>	4F	9							
354	B 60 R			5E, <i>E</i>	5F, <i>E</i>	10E, E	10F	35					
358	B 65 G				7	12E, E	12F			30			
2.5	T 0.4 T	105 5	100 0	445 5	445	10							
366	E 04 F	10E, <i>E</i>	10F, E	11E, <i>E</i>	11F	18							
	F 16 B				12	19							
267	D ((D			12E	12E								
367	B 66 D			13E	13F								
	B 66 F E 04 G		11	14E	14F	20							
	E 04 G		11 12	15E, <i>E</i>	15F	20							
	E 00 C		12	10									
389	B 61 L		18	23									
309	DOLL		10	23									
406	G 06 F						28	51					
100	G 11 C			24E, E	24F	29E	29F	52				 	
	0 11 0			2 .2., 2	2.11	272	2/1	32					
407	H 01 B				25	30E	30F	53					
408	B 65 G		19	26								1	
	H 01 L		20	27									
419	G 01 M		41	33E	33F	53E, <i>E</i>	53F	60					
421	G 21 B			34E, <i>E</i>	34F	54, E		61					
	G 21 C				35			62					
	H 05 H				36	55							

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Project	Class or subclass affected	Approved amendments contained in Annex to document IPC/WG/-											
		6/	' 5	5,	/3	4	/5	3	/3	2	./3	1.	/2
		Е	F	Е	F	Е	F	Е	F	Е	F	Е	F
423	H 01 L	44E, E	44F	39, E		56							
	H 01 S		45	40		57							
	H 05 B		46	41, E		58							

3. The Committee of Experts is invited to adopt the amendments to the IPC proposed in Technical Annexes 1 to 27 to this document.

[Technical Annexes follow]

TECHNICAL ANNEXES

ANNEX 1 A 61 B [Project-Rapporteur: 341/AT] <CE31030E> 5/04 --- parts thereof (electrically conductive preparations for use in therapy or testing in vivo A 61 K 50/00) N Heading after 18/00 Informative note References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group: Electrically conductive preparations for use in therapy or testing in vivo, e.g conductive adhesives or gels to be used with electrodes, A 61 K 50/00. **ANNEX** 2 A 61 K [Project-Rapporteur: 341/AT] <CE31023E> N Electrically conductive preparations for use in therapy or testing in 50/00 vivo, e.g. conductive adhesives or gels to be used with electrodes for electrocardiography (ECG) or for transcutaneous drug administration N *Note(s) after* 50/00 Informative notes References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group: Electrodes specially adapted for electrocardiography A 61 B 5/0408 Electrodes specially adapted for foetal cardiography A 61 B 5/0448 Electrodes specially adapted for electroencephalography A 61 B 5/0478 Electrodes specially adapted for electromyography A 61 B 5/0492 Electrodes for electrotherapy A 61 N 1/04.

ANNEX 3 A 61 L [Project-Rapporteur : 341/AT] <CE31031E>

15/58

• • • Adhesives (electrically conductive adhesives for use in

 Adhesives (electrically conductive adhesives for use in therapy or testing in vivo A 61 K 50/00)

24/00

-- colostomy devices (electrically conductive adhesives for use in therapy or testing in vivo A 61 K 50/00)

ANNEX	4	A 61 N [Proj	ect-Rapporteur : 341/AT]	<ce31024e></ce31024e>
	1/00		pparatus 5/00; electrically conductivor testing in vivo A 61 K 50/00)	e preparations
ANNEX	5	B 02 C [Proje	ect-Rapporteur : 346/AT]	<ce31002e></ce31002e>
D	18/40	(covered by 18/00	0 - 18/38)	
D	18/42	(covered by 18/00	0, E 03 C 1/266)	
D	18/44	(transferred to B	29 B 17/04, covered by 18/00)	
D	19/12	(covered by 19/00	0)	
D	19/14	(covered by 19/00	0)	
ANNEX	6	B 29 B [Proje	ect-Rapporteur : 346/AT]	<ce31003e></ce31003e>
N ANNEX	17/04	• Disintegrating	plastics (9/02, 11/02, 13/10 take pro	
N		• Disintegrating	-	ecedence)
N	17/04	Disintegrating B 60 R [Projection of the content of the c	plastics (9/02, 11/02, 13/10 take pro	ecedence) <ce31007e></ce31007e>
N ANNEX	7	Disintegrating B 60 R [Projetting] including management roll-over	plastics (9/02, 11/02, 13/10 take pro- ect-Rapporteur : 354/DE]	ecedence) <ce31007e></ce31007e>
N ANNEX N	7 21/013	Disintegrating B 60 R [Projetting in the content of the c	plastics (9/02, 11/02, 13/10 take protect-Rapporteur : 354/DE] neans for detecting collisions, impen	ecedence) <ce31007e> ding collisions or</ce31007e>
N ANNEX N N	7 21/013 21/0132	 Disintegrating B 60 R [Projetting of the projetting of the projett	plastics (9/02, 11/02, 13/10 take protect-Rapporteur: 354/DE] neans for detecting collisions, impensive to vehicle motion parameters	ecedence) <ce31007e> ding collisions or acle</ce31007e>
N ANNEX N N N	7 21/013 21/0132 21/0134	• Disintegrating B 60 R [Projetting or including or response to the response to the including or including o	plastics (9/02, 11/02, 13/10 take protect-Rapporteur: 354/DE] neans for detecting collisions, impensive to vehicle motion parameters ive to imminent contact with an obst	<pre>cecedence) <ce31007e> ding collisions or acle e position of</ce31007e></pre>

C	21/20	• • • Arrangements for storing inflatable members in their non-use or deflated condition; Arrangement or mounting of air bag modules or components
N	21/203	• • • in steering wheels or steering columns
N	21/205	• • • in dashboards
N	21/207	• • • in vehicle seats
N	21/210	• • • in vehicle side panels, e.g. doors or pillars
N	21/213	• • • in vehicle roofs, e.g. in roof frames
N	21/215	• • • characterised by the covers for the inflatable member
N	21/217	• • • • Inflation fluid source retainers, e.g. reaction canisters; Connection of bags, diffusers or inflation fluid sources thereto
D	21/22	(transferred to 21/20, 21/231)
N	21/23	• • • Inflatable members
N	21/231	• • • characterised by their shape, e.g. shaped with respect to a specific part of the occupant's body (21/233 takes precedence)
N	21/233	• • • comprising a plurality of individual compartments; comprising two or more bag-like members, one within the other
N	21/235	• • • characterised by their material
N	21/237	• • • characterised by the way they are folded
N	21/239	• • • characterised by their venting means
D	21/24	(transferred to 21/233)
	21/26	• • characterised by the inflation fluid source or means to control inflation fluid flow
N	21/264	• • • using instantaneous generation of gas (21/268 takes precedence)
N	21/268	• • • using instantaneous release of stored pressurised gas
N	21/272	• • • • with means for increasing the pressure of the gas when inflation is required, e.g. hybrid inflators
N	21/276	• • • with means to vent the inflation fluid source, e.g. in case of overpressure
D	21/28	(transferred to 21/239, 21/276)
D	21/32	(covered by 21/16)

N

21/33

• • Arrangements for non-electric triggering of inflation

ANNEX	8	B 61 L [Project-Ra	pporteur : 389/RU]	<ce31051e></ce31051e>
C	23/18		ted for maintaining a safe dis sicle trains depending upon s	
	23/34	• for indicating the – –	_	
ANNEX	9	B 65 G [Project-Ra	apporteur : 358/AT]	<ce31009e></ce31009e>
C	69/28	• Loading ramps; Load	ding docks (as road – – –	
N	69/30	• • Non-permanently	installed loading ramps, e.g.	transportable
N	69/32	• • Shelters, surround	ds or sealing arrangements fo	or loading docks
N	69/34	 Accessories, e.g. v or bumpers 	vehicle restrainers, wheel blo	ckers, positioners
ANNEX	9	B 65 G [Project-Ra	pporteur : 408/NO]	<ce31039e></ce31039e>
С	49/07	semiconductor wa	r wafers (specially adapted fo yfers during manufacture or t electric solid state devices o	reatment of
ANNEX	10	B 66 D [Project-Ra	apporteur : 367/DE]	<ce31045e></ce31045e>
AITILA				

ANNEX	11	B 66 F	[Project-Rapporteur: 367/DE]	<ce31046e></ce31046e>
	Title	wit	th lifting devices E 04 G 1/22, 3/28; lifting de	vices for – – –
ANNEX	12	C 09 J	[Project-Rapporteur : 341/AT]	<ce31032e></ce31032e>
	9/02		rically-conducting adhesives (electrically conally adapted for use in therapy or testing <u>in vi</u>	
ANNEX	13	E 03 C	[Project-Rapporteur : 346/AT]	<ce31004e></ce31004e>
	1/26	• •	– devices for waste pipes or outlets (1/28 –	
	1/266	• • •	Arrangement of disintegrating apparatus in voutlets; Disintegrating apparatus specially ac installation in waste pipes or outlets	
N	Note(s) after 1/266			
			<u>Informative note</u>	
			References listed below indicate IPC particles also be of interest when carrying out a of the subject matter covered by the pre-	search in respect
			Disintegrating apparatus in general B	02 C
ANNEX	14	E 04 F	[Project-Rapporteur : 366/DE]	<ce31011e></ce31011e>
N	13/07	-	osed of covering or lining elements; Sub-struening means therefor	ctures therefor;

lining elements

13/072

13/073

N

N

composed of specially adapted, structured or shaped covering or

• • for particular building parts, e.g. corners or columns

N	13/074	• • for accommodating service installations or utility lines, e.g. heating conduits, electrical lines, lighting devices or service outlets
N	13/075	• • for insulation or surface protection, e.g. against noise or impact
N	13/076	• • characterised by the joints between neighbouring elements, e.g. with joint fillings or with tongue and groove connections
N	13/077	• • composed of several layers, e.g. sandwich panels (13/075 takes precedence)
N	13/078	Stretched foil- or web-like elements attached with edge gripping devices
С	13/08	• composed of a plurality of similar covering or lining elements (13/072 takes precedence; borders, skirtings 19/02)
N	Note(s) before 13/09	
		Group 13/09 takes precedence over groups 13/10 to 13/18.
N	13/09	• • of elements attached to a common web, support plate or grid
C	13/10	<add 1="" dot=""></add>
C	13/12	<add 1="" dot=""></add>
C	13/14	• • of stone or stone-like materials, e.g. ceramics; of glass
N	13/15	• • • characterised by the use of glass elements
C	13/16	• • of fibres or chips, e.g. bonded with synthetic resins
C	13/18	<add 1="" dot=""></add>
N	13/20	• Fastening means specially adapted for covering or lining elements
N	13/22	• • Anchors, support angles or consoles
N	13/23	• • • adjustable
N	13/24	• • Hidden fastening means on the rear of the covering or lining elements (13/30 takes precedence)
N	13/25	• • • adjustable
N	13/26	• • Edge engaging fastening means, e.g. clamps, clips or border profiles
N	13/28	• • • adjustable
N	13/30	• • Magnetic fastening means

19/02 <Unchanged>

ANNEX	15	E 04 G [Project-Rapporteur : 367/DE] <ce31013e></ce31013e>
	1/00	Scaffolds primarily resting – – –
С	1/14	• Comprising essentially pre-assembled two-dimensional frame-like elements, e.g. of rods in L- or H-shape, with or
C	1/15	• precedence); Platforms (boards or planks therefor 5/08)
D	1/16	(transferred to 1/17, 5/16)
N	1/17	 Comprising essentially pre-assembled three-dimensional elements, e.g. cubic elements
	1/20	• • Scaffolds comprising upright – –
	1/22	• • Scaffolds having a – – –
D	1/26	(transferred to 5/00)
	1/30	 Ladder scaffolds
N	1/38	 Scaffolds partly supported by the building (ladders attachable to structures E 06 C 1/34)
N	3/18	• supported by cantilevers or other provisions mounted in openings in the building, e.g. window openings (3/28 takes precedence)
N	3/20	 supported by walls (3/28 takes precedence; wall-anchors for supporting scaffolds 5/04; consoles 5/06)
N	3/22	• supported by roofs or ceilings (3/28 takes precedence)
N	3/24	• specially adapted for particular parts of buildings or for buildings of particular shape, e.g. chimney stacks or pylons (3/28 takes precedence)
N	3/26	 specially adapted for working on roofs
N	3/28	Mobile scaffolds; Scaffolds with mobile platforms
N	3/30	 suspended by flexible supporting elements, e.g. cables
N	3/32	 Hoisting devices; Safety devices
N	3/34	 characterised by supporting structures provided on the roofs
C	5/00	Component parts or accessories for scaffolds (connections 7/00)
	5/08	• or planks
N	5/10	Steps or ladders specially adapted for scaffolds

N ANNEX	18	G 01 M	E 04 G 5/04 [Project-Rappor	Fastening means specially covering or lining element buildings Fastening scaffolds ==>			
N				covering or lining elements buildings			
N				covering or lining elements buildings			
N			E 04 F 13/20				
				C			
	ան ան		<== for roof d	rainage			
	Note(s) after the title						
ANNEX	17	F 16 B	[Project-Rappor	rteur : 366/DE]	<ce31012e></ce31012e>		
	7/42	•1	herefor (for scaffold	d elements E 04 G 5/02)			
NNEX	16	E 06 C	[Project-Rappor	rteur : 367/DE]	<ce31052e></ce31052e>		
	27/00		ips (for scaffolds 1/2				
	21/32		relating to scaffolds	,			
	21/24	-	structures for scaffol	lds 1/26)			
N	7/34	• • wit	coupling elements using positive engagement, e.g. hooks or				
1 V	7/32	• • wit	n coupling elements using wedges				
N	5/16	• Struts	Struts or stiffening rods, e.g. diagonal rods				
N N	3/14	• Railin	Railings				
	5/14						

N	Note(s) after 15/00	
		<u>Informative note</u>
		References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:
		Measurement of mechanical vibrations in general $G\ 01\ H$
		Analysing gases in general G 01 N
		Arrangements for testing electrical properties; Arrangements for locating electric faults; Arrangements for electrical testing characterised by what is being tested not provided for elsewhere G 01 R 31/00.
N	15/02	Details or accessories of testing apparatus
N	15/04	• Testing of internal-combustion engines, e.g. diagnostic testing of piston engines
N	Note(s) before 15/05	
		Group 15/05 takes precedence over groups 15/06 to 15/12.
N	15/05	 by combined monitoring of two or more different engine parameters
N	15/06	• by monitoring positions of pistons or cranks
N	15/08	by monitoring pressure in cylinders
N	15/09	• by monitoring pressure in fluid ducts, e.g. in lubrication or cooling parts
N	15/10	by monitoring exhaust gases
N	15/11	by detecting misfire
N	15/12	• • by monitoring vibrations
N	15/14	• Testing of gas-turbine plants or jet-propulsion plants

N Note(s) after 15/14

Informative note

References listed below indicate IPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group:

Rocket-engine plants characterised by specially adapted arrangements for testing or measuring F 02 K 9/96.

ANNEX	19	G 06 F	[Project-Rapporteur : 406/EP]	<ce31033e></ce31033e>				
	11/00	static	static stores G 11 C 29/00; coding, decoding					
С	17/50	• Computer-aided design (for the design of test circuits for static stores G 11 C 29/54)						
ANNEX	20	G 11 C	[Project-Rapporteur : 406/EP]	<ce31014e></ce31014e>				
	Note(s) after the title							
N		(3)	In this subclass, the following ten meaning indicated:	rms are used with the				
N			 "storage element" is an element least one item of information means for writing-in or readinformation; 	on and is provided with				
N			 "memory" is a device, incluwhich can hold information desired. 	0 0				
		<delete< td=""><td>former note (3)></td><td></td></delete<>	former note (3)>					
	11/4078	• • • •	• • • Test cells (protection during checking or testing)	•				
C	29/00	Checking s or offline o	tores for correct operation; Testing peration	stores during standby				
N	29/02	• Detection	n or location of defective auxiliary o	circuits, e.g. defective				

refresh counters

N	29/04	 Detection or location of defective memory elements
N	29/06	Acceleration testing
N	29/08	• Functional testing, e.g. testing during refresh, power-on self testing (POST) or distributed testing
N	29/10	 Test algorithms, e.g. memory scan (MScan) algorithms; Test patterns, e.g. checkerboard patterns
N	29/12	• • Built-in arrangements for testing, e.g. built-in self testing (BIST)
N	29/14	• • • Implementation of control logic, e.g. test mode decoders
N	29/16	• • • • using microprogrammed units, e.g. state machines
N	29/18	 • • • Address generation devices; Devices for accessing memories, e.g. details of addressing circuits
N	29/20	• • • • using counters or linear-feedback shift registers (LFSR)
N	29/22	• • • • Accessing serial memories
N	29/24	• • • • Accessing extra cells, e.g. dummy cells or redundant cells
N	29/26	• • • • Accessing multiple arrays (29/24 takes precedence)
N	29/28	• • • • Dependent multiple arrays, e.g. multi-bit arrays
N	29/30	• • • • Accessing single arrays
N	29/32	• • • • • Serial access; Scan testing
N	29/34	• • • • • Accessing multiple bits simultaneously
N	29/36	 • • Data generation devices, e.g. data inverters
N	29/38	Response verification devices
N	29/40	• • • • using compression techniques
N	29/42	• • • • using error correcting codes (ECC) or parity check
N	29/44	• • • Indication or identification of errors, e.g. for repair
N	29/46	• • • Test trigger logic

N	29/48	 Arrangements in static stores specially adapted for testing by means external to the store, e.g. using direct memory access (DMA) or using auxiliary access paths (external testing equipment 29/56)
N	29/50	 Marginal testing, e.g. race, voltage or current testing
N	29/52	• Protection of memory contents; Detection of errors in memory contents
N	29/54	• Arrangements for designing test circuits, e.g. design for test (DFT) tools
N	29/56	• External testing equipment for static stores, e.g. automatic test equipment (ATE); Interfaces therefor

ANNEX	21	G 21 B	[Project-Rapporteur : 421/RU]	<ce31021e></ce31021e>	
\boldsymbol{C}	1/00	Thermon	nuclear fusion reactors		
N	1/01	Hybrid fission-fusion nuclear reactors			
D	1/02	(transfer	red to 1/00, 3/00)		
N	1/03	• with i	nertial plasma confinement		
N	1/05	• with n	nagnetic or electric plasma confinement		
N	1/11	• Detail	ds .		
N	1/13	• • Fin	rst wall; Blanket; Divertor		
N	1/15	 Particle injectors for producing thermonuclear fusion reactions, e.g. pellet injectors 			
N	1/17	• • Va	cuum chambers; Vacuum systems		
N	1/19	• • Ta	rgets for producing thermonuclear fusion rea	actions	
N	1/21	• • Ele	ectric power supply systems, e.g. for magnet s	systems	
N	1/23	-	otical systems, e.g. for irradiating targets, for for plasma diagnostics	heating plasma	
N	1/25	• Maint	enance, e.g. repair or remote inspection		
N	3/00	Low temp	perature nuclear fusion reactors, e.g. alleged	d cold fusion	

ANNEX	22	G 21 C	[Project-Rapporteur : 421/RU]	<ce31034e></ce31034e>
	Title	G 06 G 21 B; -	6 G 7/54; fusion reactors, hybrid fission-fusio	on reactors
ANNEX	23	H 01 B	[Project-Rapporteur : 407/RU]	<ce31017e></ce31017e>
	Note(s) after the title			
N		(3)	In groups 1/00 to 7/00 and 17/00, multiclassification is applied to conductors, bodies, insulators or insulating bodies, their form and to their material, so that and the material are of interest, the subclassified in each of the relevant groups.	conductive with regard to t if both the form bject matter is
	3/30	• • plas	stics; resins; waxes	
N	Note(s) after 3/30			
			Group 3/47 takes precedence over grou	ups 3/32 to 3/46
N	3/47	• • • j	fibre-reinforced plastics, e.g. glass-reinforce	ed plastics

• • fibrous materials (fibre-reinforced plastics 3/47)

C

3/48

ANNEX	24	H 01 L	[Project-Rapporteur : 408/NO]	<ce31038e></ce31038e>	
	Note(s) after the title				
		(2)	with the meaning indicated:		
N			 "wafer" means a slice of semicond crystalline substrate material, whi modified by impurity diffusion (do implantation or epitaxy, and whos can be processed into arrays of dis components or integrated circuits; 	ch can be ping), ion e active surface screte	
			<pre>- "solid state body" ==></pre>		
	Note(s) after 21/00				
			21/02 to 21/67.		
N	21/67	 Apparatus specially adapted for handling semiconductor or electric solid state devices during manufacture or treatment thereof; Apparatus specially adapted for handling wafers during manufacture or treatment of semiconductor or electric solid state devices or components 			
N	21/673	• • usi	using specially adapted carriers		
N	21/677	• • for	conveying, e.g. between different work statio	ns	
C	21/68	• • for	positioning, orientation or alignment (for co	nveying 21/677)	
N	21/683		• • for supporting or gripping (for conveying 21/677, for positioning, orientation or alignment 21/68)		
N	21/687	• • •	using mechanical means, e.g. chucks, clamps	s or pinches	
ANNEX	24	H 01 L	[Project-Rapporteur : 423/DE]	<ce31040e></ce31040e>	
C	21/00		s or apparatus specially adapted for (specially adapted for the manufacture:		
C	21/02	•p	parts thereof		
C	21/64	 thereof, not specially adapted for a single type of device provided 31/00 to 51/00 			

	Note(s) after 23/00			
		<pre>- <== by that group;</pre>		
		- 31/00 to 51/00, which details		
C	25/03	• 27/00 to 51/00, e.g. assemblies		
C	25/16	• 27/00 to 51/00, e.g. forming		
C	25/18	• 27/00 to 51/00		
C	27/00	or apparatus specially adapted for $31/00$ to $51/00$; details thereof $23/00$, $29/00$ to $51/00$; assemblies consisting $$		
	Note(s) after 27/00			
		(1) In this group, in the absence – –		
	27/02	 including semiconductor components specially adapted for rectifying, oscillating, amplifying or switching and having at least one potential-jump barrier or surface barrier; including integrated – – 		
	27/14	 electromagnetic radiation of shorter wavelength or corpuscular radiation and specially adapted either for the conversion 		
	27/15	• or surface barrier, specially adapted for		
N	27/28	• including components using organic materials as the active part, or using a combination of organic materials with other materials as the active part		
N	27/30	• • with components specially adapted for sensing infra-red radiation, light, electromagnetic radiation of shorter wavelength, or corpuscular radiation; with components specially adapted for either the conversion of the energy of such radiation into electrical energy or for the control of electrical energy by such radiation		
N	27/32	• with components specially adapted for light emission, e.g. flat- panel displays using organic light-emitting diodes		
	29/00	Semiconductor devices specially adapted for rectifying, amplifying, oscillating or switching and having at least one potential-jump barrier or surface barrier; Capacitors or resistors with $$ to $47/00$, $51/05$ take precedence; processes or apparatus specially adapted for the $$		
C	31/00	radiation and specially adapted either or apparatus specially adapted for the manufacture Details thereof (51/42 takes precedence;		
	31/12	 surface barrier specially adapted for 		

	31/18	 Processes or apparatus specially adapted for the manufacture — — parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00) 		
C 33/00		surface barrier specially adapted for or apparatus specially adapted for the manufacture Details thereof (51/50 takes precedence; devices consisting of a plurality of components formed in or on a common substrate 27/00; couplings of light guides		
	35/00	– – – or apparatus specially adapted for the manufacture – – –		
	35/34	 Processes or apparatus specially adapted for the manufacture — — parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00) 		
	37/00	— — or apparatus specially adapted for the manufacture — — —		
	39/00	——— or apparatus specially adapted for the manufacture———		
	39/24	 Processes or apparatus specially adapted for the manufacture — — parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00; magnetic — — 		
	41/00	– – – or apparatus specially adapted for the manufacture – – –		
	41/22	 Processes or apparatus specially adapted for the manufacture — — parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00) 		
	43/00	— — or apparatus specially adapted for the manufacture — — —		
	43/12	 Processes or apparatus specially adapted for the manufacture — — parts thereof (for manufacture or treatment of semiconductor or solid state devices or of parts thereof in general 21/00) 		
	45/00	Solid state devices specially adapted for $$ or apparatus specially adapted for the manufacture $$		
	47/00	or apparatus specially adapted for the manufacture $$		
C	49/00	47/00 and $51/00$ and not provided for in any $$ or apparatus specially adapted for the manufacture $$		
С	51/00	Solid state devices using organic — — with other materials as the active part; Processes — — parts thereof (devices consisting of a plurality of components formed in or on a common substrate 27/28; thermoelectric devices using organic material 35/00, 37/00; piezoelectric, electrostrictive or magnetostrictive elements using organic material 41/00)		
N	51/05	 specially adapted for rectifying, amplifying, oscillating or switching and having at least one potential-jump barrier or surface barrier; Capacitors or resistors with at least one potential-jump barrier or surface barrier 		

C	33/00	light emission H 01 L 27/15, 33/00; organic light emitting devices H 01 L 27/32, 51/50; lasers H 01 S 3/00, 5/00; compositions per se, see the		
ANNEX	26	H 05 B [Project-Rapporteur : 423/DE] <ce31042e></ce31042e>		
N	5/36	• comprising organic materials (dye lasers 3/213)		
	5/34	 • lasers (GRINSCH-lasers) (5/36 takes precedence) 		
	5/32	 • double- hetero-structures (5/34, 5/36 take precedence) 		
	5/30	• region; Materials used for the active region		
ANNEX	25	H 01 S [Project-Rapporteur : 423/DE] <ce31041e></ce31041e>		
		ireannem of such acrices or of parts mereof		
N	51/56	 Processes or apparatus specially adapted for the manufacture or treatment of such devices or of parts thereof 		
N	51/54	 Selection of materials (organic luminescent materials C 09 K 11/06) 		
N	51/52	• • Details of devices		
N	51/50	• specially adapted for light emission, e.g. organic light emitting diodes (OLED) or polymer light emitting devices (PLED) (organic semiconductor lasers H 01 S 5/36)		
N	51/48	 Processes or apparatus specially adapted for the manufacture or treatment of such devices or of parts thereof 		
N	51/46	Selection of materials		
N	51/44	• • Details of devices		
N	51/42	• specially adapted for sensing infra-red radiation, light, electromagnetic radiation of shorter wavelength, or corpuscular radiation; specially adapted either for the conversion of the energy of such radiation into electrical energy or for the control of electrical energy by such radiation		
C	51/40	• treatment of such devices or		
C	51/30	<add 1="" dot=""></add>		
D	51/20	(transferred to 51/05, 51/42, 51/50)		
C	51/10	<add 1="" dot=""></add>		
C	E 1 /10	. 7. 7. 7. 7. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1.		

ANNEX	27	Н 05 Н	[Project-Rapporteur : 421/RU]	<ce31022e></ce31022e>
Title PLASMA TECHNIQUE (ion-beam tubes H 01 J 27/00;				27/00;
1/00 Generating plasma; Handling plasma (application of plasma technique in thermonuclear fusion reactors G 21 B 1/00)			•	

[End of Technical Annexes and of document]